

Title (en)  
Method for manufacturing chipboards

Title (de)  
Verfahren zur Herstellung von Spanplatten

Title (fr)  
Procédé de fabrication de panneaux de particules

Publication  
**EP 2216149 B2 20171115 (DE)**

Application  
**EP 10152355 A 20100202**

Priority  
DE 102009000623 A 20090204

Abstract (en)  
[origin: EP2216149A1] The method involves forming chipping for an intermediate layer (4) and chipping for covering layers of a chip tray (1) separately. The chipping is formed from the fresh wood for external covering layer (2). The chipping is formed from the matured timber for internal covering layer (3).

IPC 8 full level  
**B27N 3/00** (2006.01); **B27N 3/14** (2006.01)

CPC (source: EP)  
**B27N 3/007** (2013.01); **B27N 3/14** (2013.01)

Citation (opposition)  
Opponent :

- DE 3820376 A1 19891221 - NOVOPAN GMBH [DE]
- CH 438709 A 19670630 - FISCHER GEORG [DE]
- DE 4434876 A1 19960404 - DIEFFENBACHER GMBH MASCHF [DE]

Cited by  
EP3778220A1; IT201900014682A1; DE202017103956U1; WO2019007538A1; US11969971B2; EP4223509A2; EP3778220B1

Designated contracting state (EPC)  
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK SM TR

DOCDB simple family (publication)  
**EP 2216149 A1 20100811; EP 2216149 B1 20110323; EP 2216149 B2 20171115**; AT E502747 T1 20110415; DE 102009000623 A1 20100805; DE 502010000007 D1 20110505

DOCDB simple family (application)  
**EP 10152355 A 20100202**; AT 10152355 T 20100202; DE 102009000623 A 20090204; DE 502010000007 T 20100202